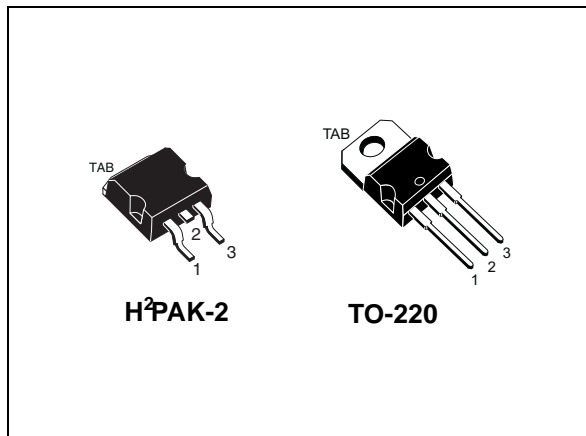


N-channel 100 V, 0.0038 Ω typ., 90 A, STripFET™ VII DeepGATE™ Power MOSFET in H²PAK-2 and TO-220 packages

Datasheet – preliminary data



Features

| Order codes | V _{DS} | R _{DS(on)max} | I _D | P _{TOT} |
|---------------|-----------------|------------------------|----------------|------------------|
| STH150N10F7-2 | 100V | 0.0045 Ω | 90 A | 250 W |
| STP150N10F7 | | | | |

- 100% avalanche tested
- Ultra low on-resistance

Applications

- Switching applications

Description

These devices utilize the 7th generation of design rules of ST's proprietary STripFET™ technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest R_{DS(on)} in all packages.

Figure 1. Internal schematic diagram

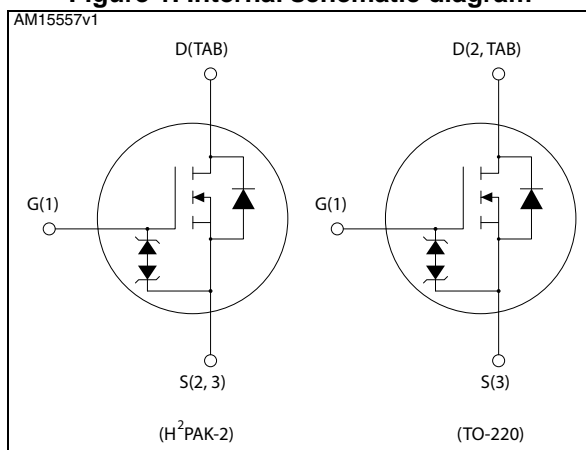


Table 1. Device summary

| Order codes | Marking | Package | Packaging |
|---------------|----------|----------------------|---------------|
| STH150N10F7-2 | 150N10F7 | H ² PAK-2 | Tape and reel |
| STP150N10F7 | | TO-220 | Tube |

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1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | | Unit |
|------------------------------------|---|--------------------|--------|------|
| | | H ² PAK | TO-220 | |
| V _{DS} | Drain-source voltage | 100 | | V |
| V _{GS} | Gate- source voltage | ±20 | | V |
| I _D | Drain current (continuous) | 90 | 90 | A |
| I _D | Drain current (continuous) at T _C = 100 °C | 90 | 90 | A |
| I _{DM} ⁽¹⁾ | Drain current (pulsed) T _C = 25 °C | 360 | 360 | A |
| P _{TOT} | Total dissipation at T _C = 25 °C | 250 | 250 | W |
| T _J T _{stg} | Operating junction temperature Storage temperature | -55 to 175 | | °C |

1. Pulse width is limited by safe operating area

Table 3. Thermal data

| Symbol | Parameter | Value | | Unit |
|-------------------------------------|---|--------------------|--------|------|
| | | H ² PAK | TO-220 | |
| R _{thj-pcb} ⁽¹⁾ | Thermal resistance junction-pcb max | 35 | | °C/W |
| R _{thj-case} | Thermal resistance junction-case max | 0.75 | | °C/W |
| R _{thj-amb} | Thermal resistance junction-ambient max | | 62.5 | °C/W |

1. When mounted on 1 inch² FR-4 board, 2 oz Cu

2 Electrical characteristics

($T_C = 25\text{ °C}$ unless otherwise specified)

Table 4. On /off states

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|-----------------------------------|--|------|--------|--------|----------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS} = 0, I_D = 250\ \mu A$ | 100 | | | V |
| I_{DSS} | Zero gate voltage drain current | $V_{GS} = 0, V_{DS} = 100\ V$ | | | 1 | μA |
| | | $V_{GS} = 0, V_{DS} = 100\ V, T_C = 125\text{ °C}$ | | | 100 | μA |
| I_{GSS} | Gate-body leakage current | $V_{DS} = 0, V_{GS} = +20\ V$ | | | 100 | nA |
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 250\ \mu A$ | 2 | | 4 | V |
| $R_{DS(on)}$ | Static drain-source on-resistance | $V_{GS} = 10\ V, I_D = 45\ A$ | | 0.0038 | 0.0045 | Ω |

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|------------|------------------------------|--|------|------|------|------|
| C_{iss} | Input capacitance | $V_{DS} = 50\ V, f = 1\ MHz, V_{GS} = 0$ | - | 6400 | - | pF |
| C_{oss} | Output capacitance | | - | 1380 | - | pF |
| C_{riss} | Reverse transfer capacitance | | - | 23 | - | pF |
| Q_g | Total gate charge | $V_{DD} = 50\ V, I_D = 90\ A, V_{GS} = 10\ V$ (see Figure 3) | - | 92 | - | nC |
| Q_{gs} | Gate-source charge | | - | TBD | - | nC |
| Q_{gd} | Gate-drain charge | | - | TBD | - | nC |

Table 6. Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---|------|------|------|------|
| $t_{d(on)}$ | Turn-on delay time | $V_{DD} = 50\ V, I_D = 45\ A, R_G = 4.7\ \Omega, V_{GS} = 10\ V$ (see Figure 2) | - | TBD | - | ns |
| t_r | Rise time | | - | TBD | - | ns |
| $t_{d(off)}$ | Turn-off delay time | | - | TBD | - | ns |
| t_f | Fall time | | - | TBD | - | ns |

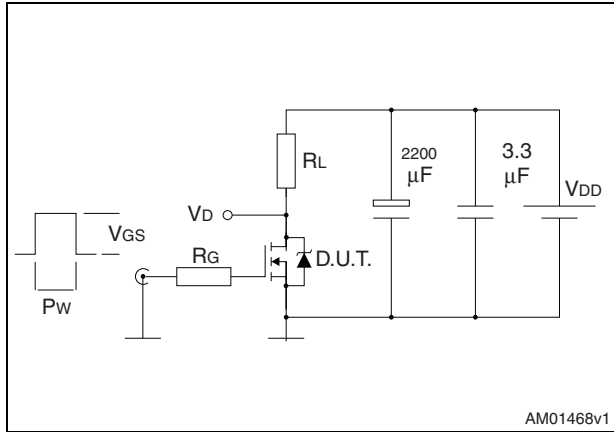
Table 7. Source drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|--|------|------|------|------|
| I_{SD} | Source-drain current | | - | - | 90 | A |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) | | - | - | 360 | A |
| $V_{SD}^{(2)}$ | Forward on voltage | $I_{SD} = 90\text{ A}$, $V_{GS} = 0$ | - | - | 1.2 | V |
| t_{rr} | Reverse recovery time | $I_{SD} = 90\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$ $V_{DD} = 80\text{ V}$, $T_J = 150\text{ °C}$ (see Figure 4) | - | - | | ns |
| Q_{rr} | Reverse recovery charge | | - | - | | nC |
| I_{RRM} | Reverse recovery current | | - | - | | A |

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%.

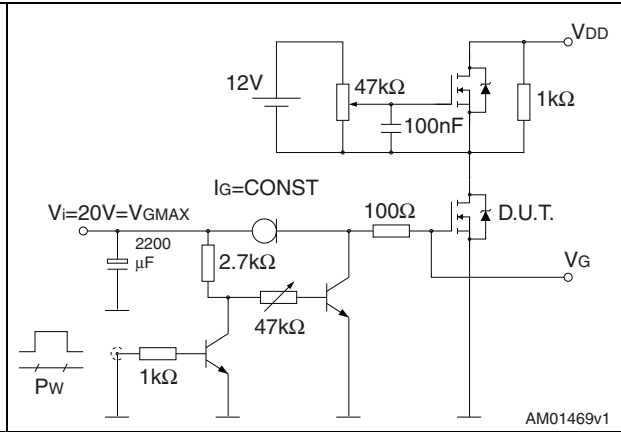
3 Test circuits

Figure 2. Switching times test circuit for resistive load



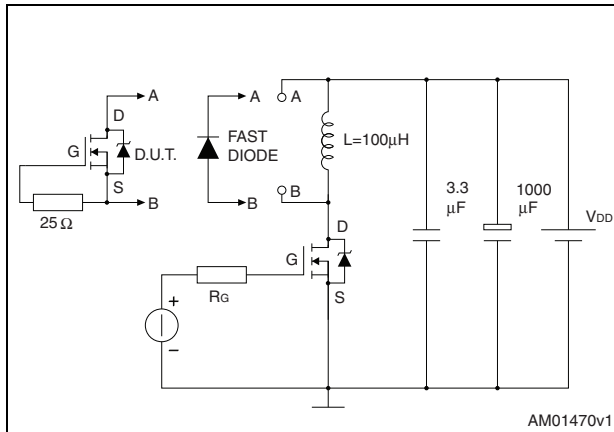
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Figure 3. Gate charge test circuit



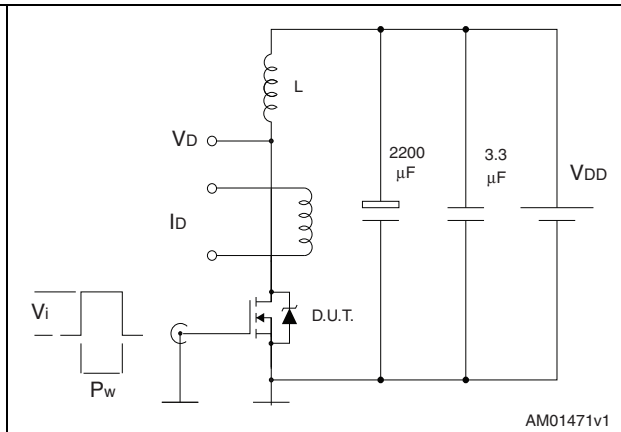
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Figure 4. Test circuit for inductive load switching and diode recovery times



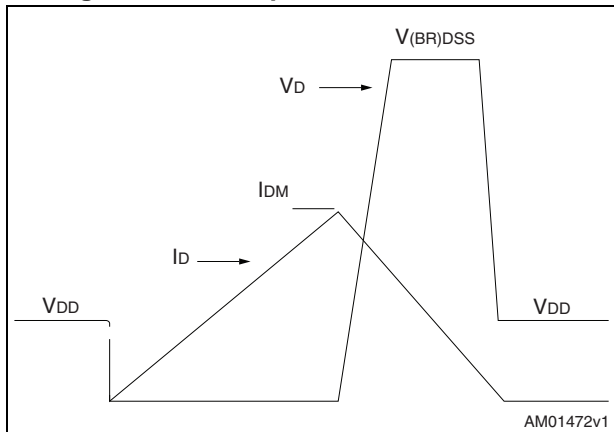
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Figure 5. Unclamped inductive load test circuit



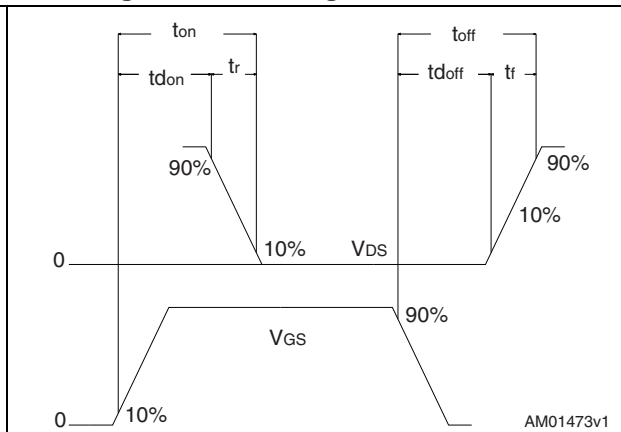
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Figure 6. Unclamped inductive waveform



AM01472v1

Figure 7. Switching time waveform



AM01473v1

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 8. H²PAK-2 mechanical data

| Dim. | mm | | |
|------|-------|------|-------|
| | Min. | Typ. | Max. |
| A | 4.30 | | 4.80 |
| A1 | 0.03 | | 0.20 |
| C | 1.17 | | 1.37 |
| e | 4.98 | | 5.18 |
| E | 0.50 | | 0.90 |
| F | 0.78 | | 0.85 |
| H | 10.00 | | 10.40 |
| H1 | 7.40 | | 7.80 |
| L | 15.30 | | 15.80 |
| L1 | 1.27 | | 1.40 |
| L2 | 4.93 | | 5.23 |
| L3 | 6.85 | | 7.25 |
| L4 | 1.5 | | 1.7 |
| M | 2.6 | | 2.9 |
| R | 0.20 | | 0.60 |
| V | 0° | | 8° |

Figure 8. H²PAK-2 drawing

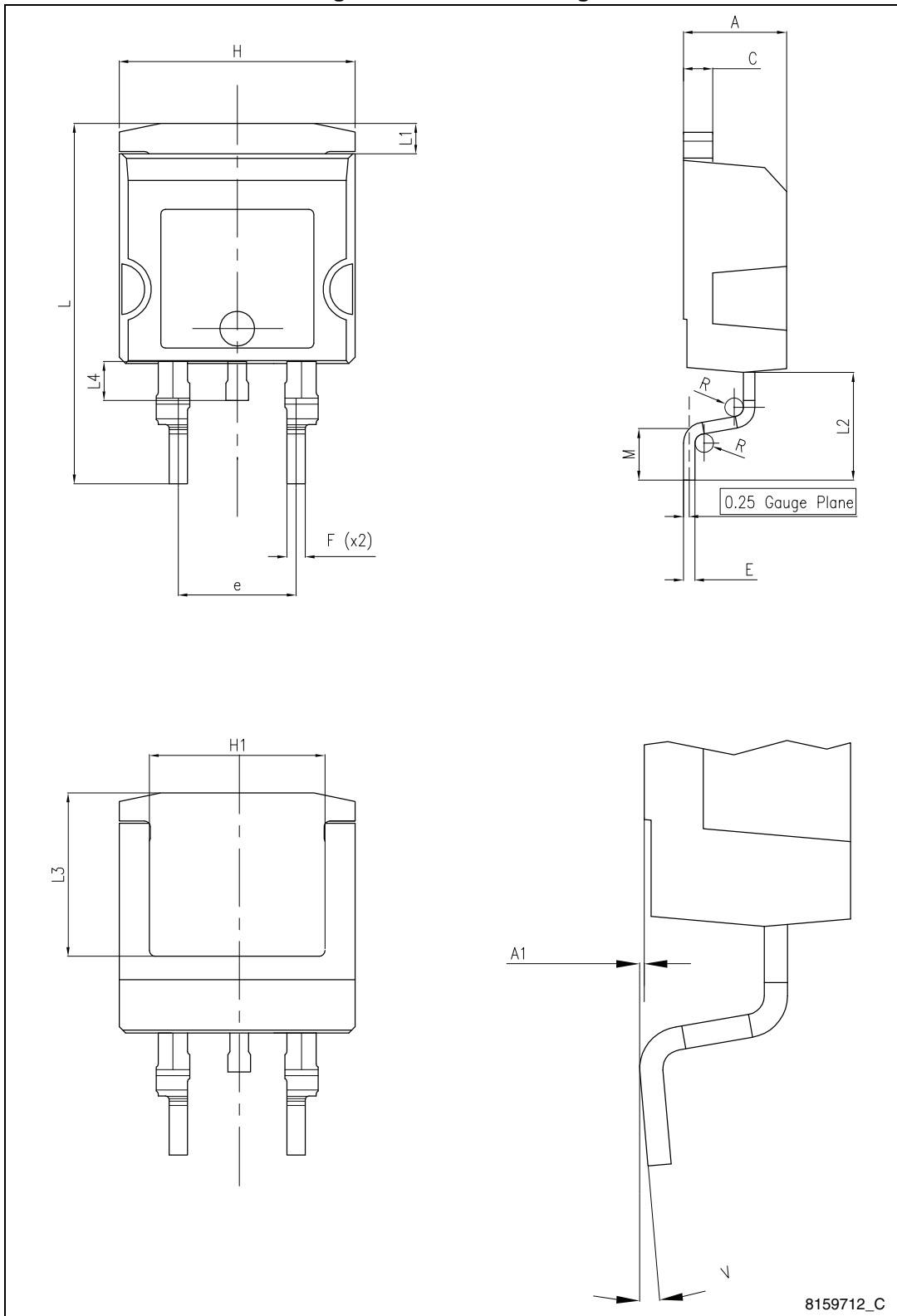
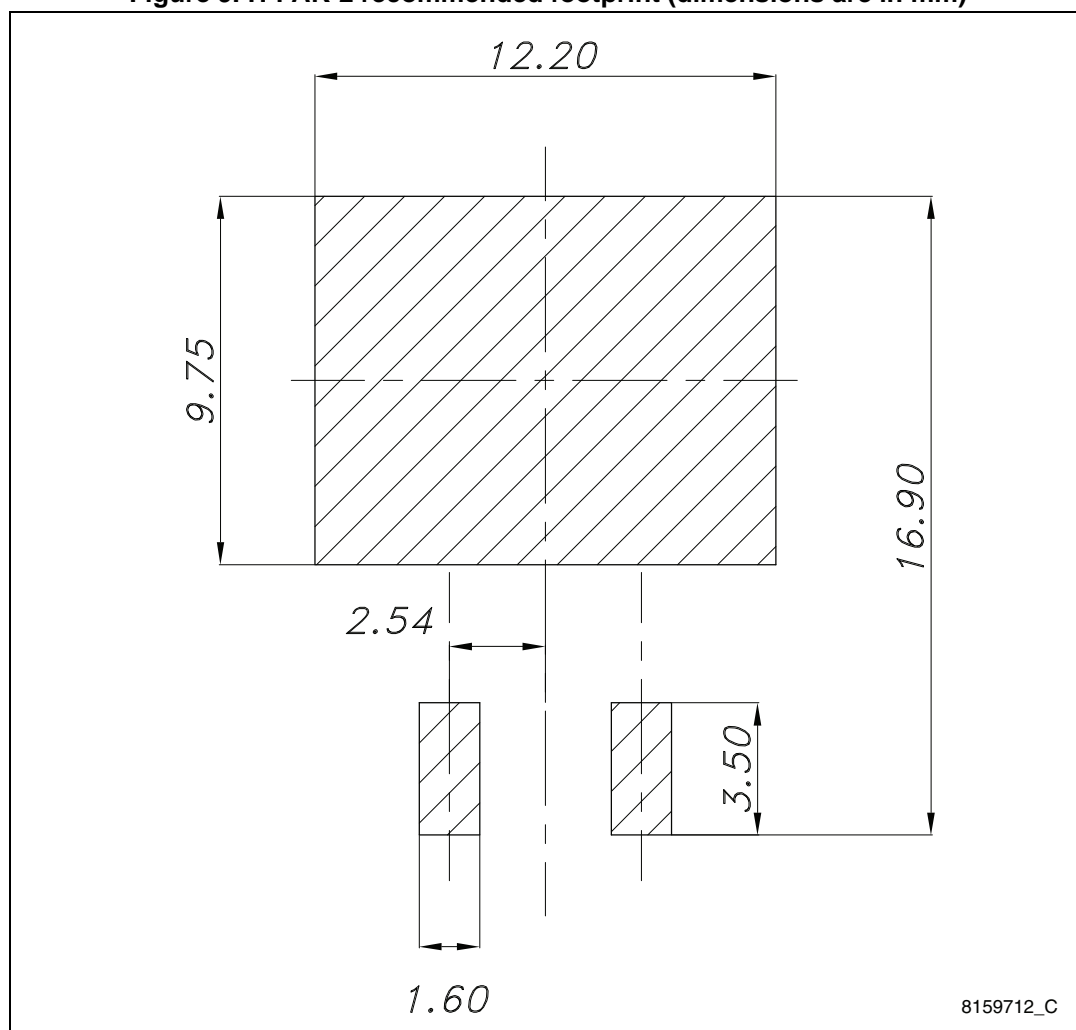


Figure 9. H²PAK-2 recommended footprint (dimensions are in mm)

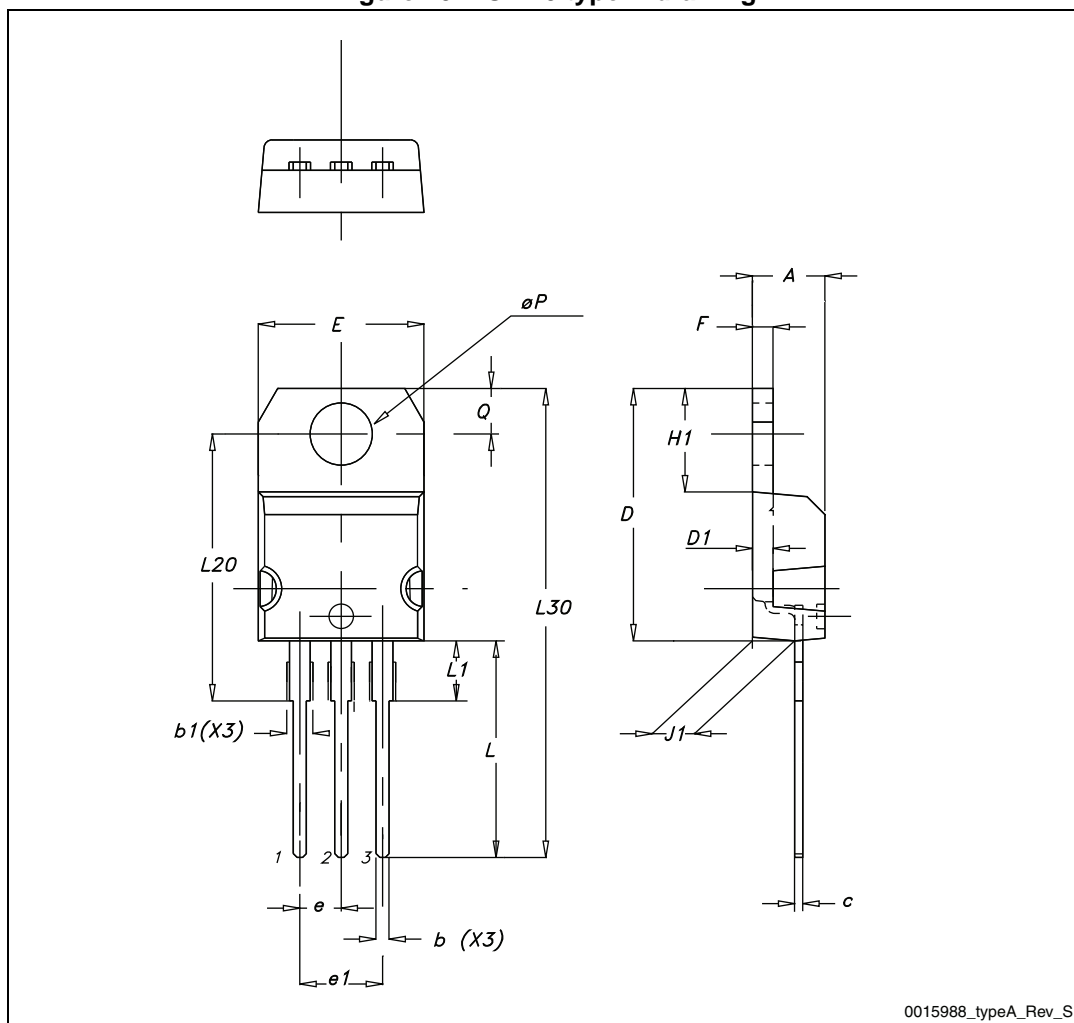


8159712_C

Table 9. TO-220 type A mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.70 |
| c | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| E | 10 | | 10.40 |
| e | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13 | | 14 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| ØP | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

Figure 10. TO-220 type A drawing



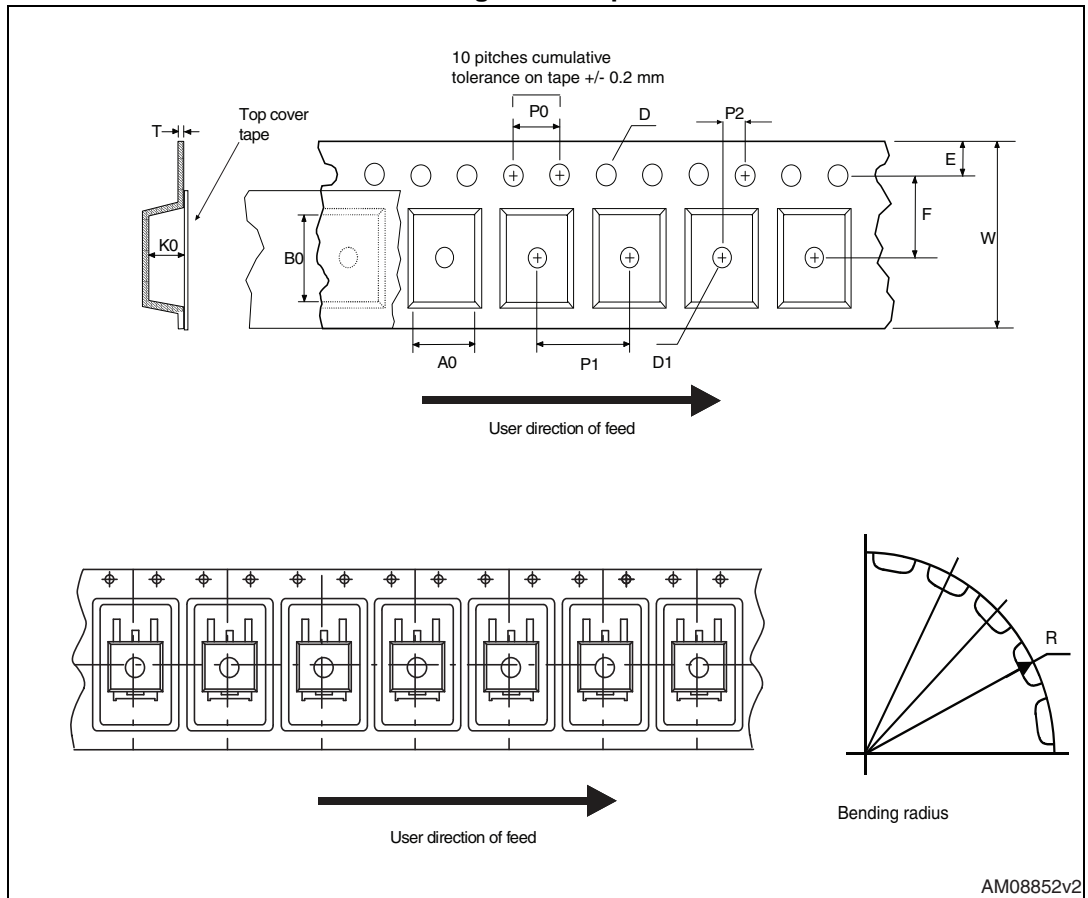
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5 Packaging mechanical data

Table 10. H²PAK-2 tape and reel mechanical data

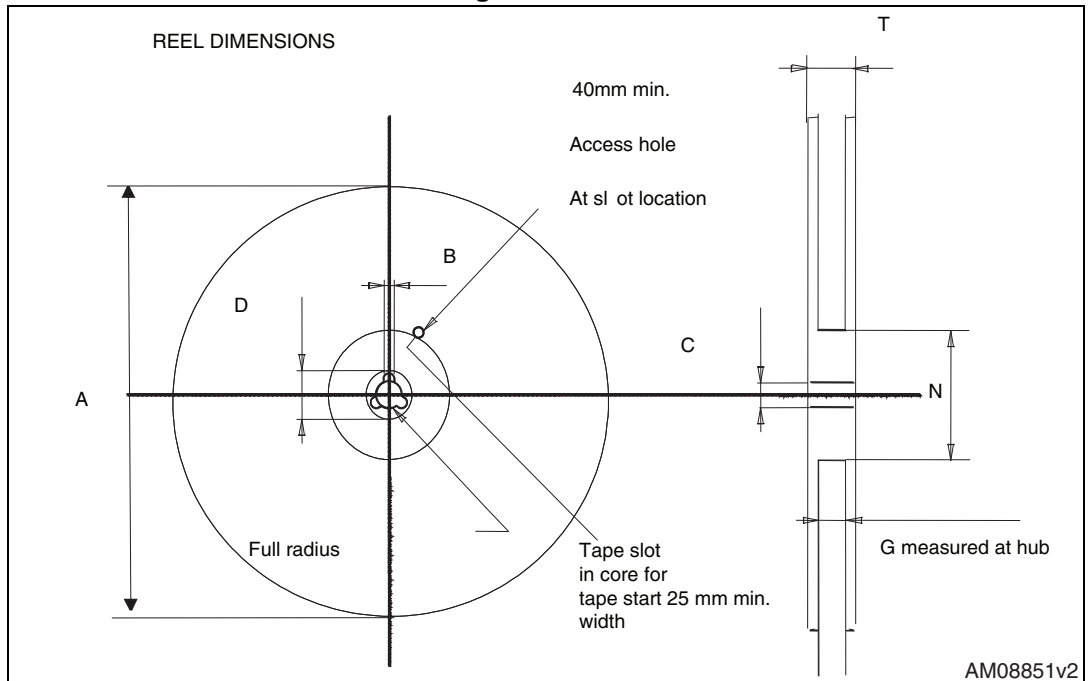
| Tape | | | Reel | | |
|------|------|------|----------|------|------|
| Dim. | mm | | Dim. | mm | |
| | Min. | Max. | | Min. | Max. |
| A0 | 10.5 | 10.7 | A | | 330 |
| B0 | 15.7 | 15.9 | B | 1.5 | |
| D | 1.5 | 1.6 | C | 12.8 | 13.2 |
| D1 | 1.59 | 1.61 | D | 20.2 | |
| E | 1.65 | 1.85 | G | 24.4 | 26.4 |
| F | 11.4 | 11.6 | N | 100 | |
| K0 | 4.8 | 5.0 | T | | 30.4 |
| P0 | 3.9 | 4.1 | | | |
| P1 | 11.9 | 12.1 | Base qty | | 1000 |
| P2 | 1.9 | 2.1 | Bulk qty | | 1000 |
| R | 50 | | | | |
| T | 0.25 | 0.35 | | | |
| W | 23.7 | 24.3 | | | |

Figure 11. Tape



AM08852v2

Figure 12. Reel



AM08851v2

6 Revision history

Table 11. Document revision history

| Date | Revision | Changes |
|-------------|----------|----------------|
| 16-Apr-2013 | 1 | First release. |

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